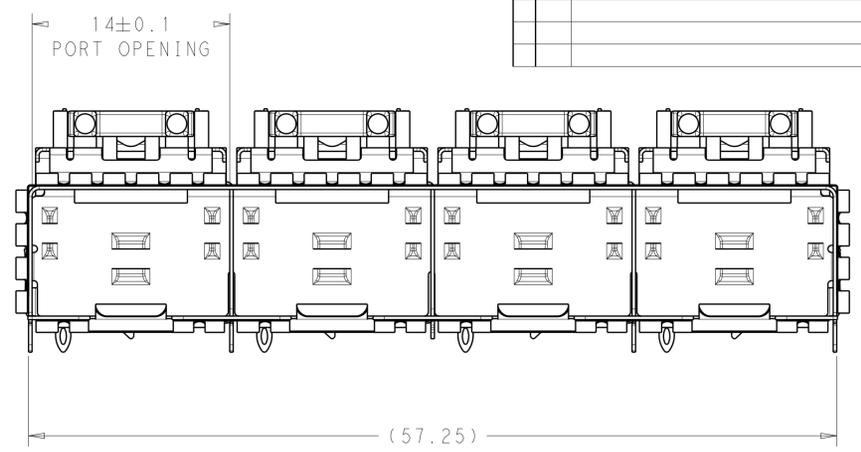
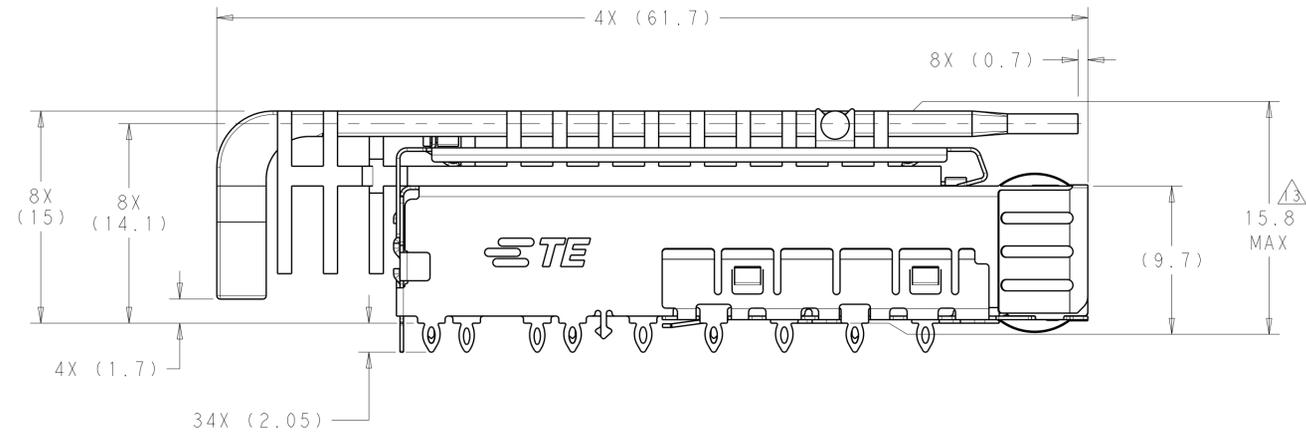
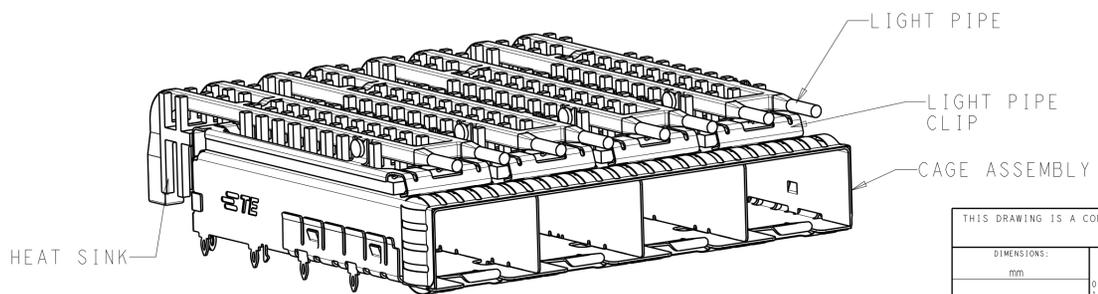
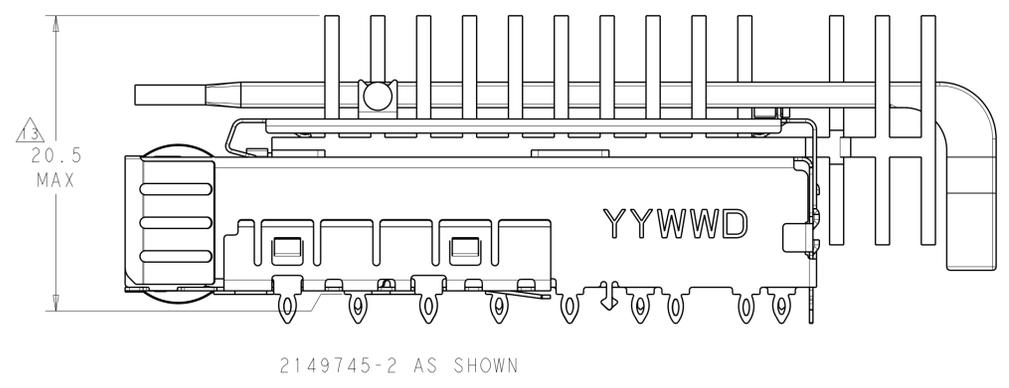
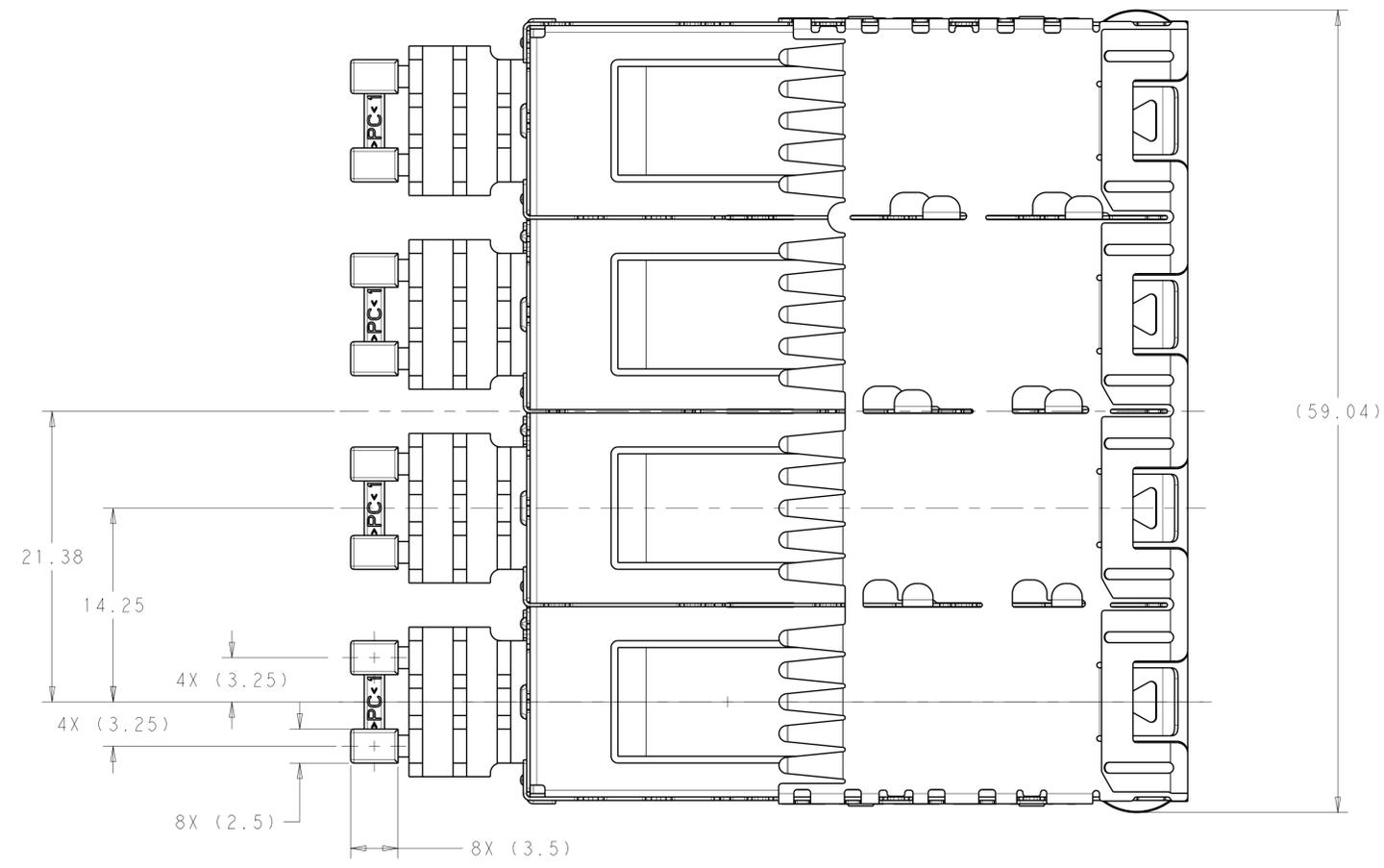


LOC		DIST		REVISIONS			
GP	00	P	LTN	DESCRIPTION	DATE	DWN	APVD
		A		RELEASED PER ECO-12-013192	10OCT2012	BMM	MRS



- △ MATERIAL:
CAGE ASSEMBLY: 0.25mm THICK NICKEL SILVER ALLOY.
LIGHTPIPE/HEATSINK CLIP: STAINLESS STEEL
LIGHT PIPE: POLYCARBONATE, CLEAR
HEATSINK: ALUMINUM
- △ FINISH:
SPRINGS: MINIMUM OF 0.8um TIN PLATE OVER A MINIMUM OF 0.8um NICKEL UNDERPLATE.
NON-PLATED EDGES PERMISSIBLE.
LIGHTPIPE/HEATSINK CLIP: PASSIVATE.
HEATSINK: ELECTROLESS NICKEL
- 3. MATES WITH SFP MSA COMPLIANT TRANSCEIVERS.
- △ PADS AND VIAS CHASSIS GROUND.
- 5. INTERPRETATION OF DATUM REFERENCE FRAME IN ACCORDANCE WITH SECT 4.4.1.1 OF ASME Y14.5M-1994.
- △ MINIMUM PCB THICKNESS:
SINGLE SIDED = 1.50mm
DOUBLE SIDED = 2.25mm
- △ HOLE PATTERN REPEATS FOR EACH PORT. SPACING BETWEEN PORTS IS 14.25mm.
- △ DATUM AND BASIC DIMENSION ESTABLISHED BY CUSTOMER.
- △ REFERENCE APPLICATION SPEC. 114-13120, HOLE A, FOR RECOMMENDED DRILL HOLE DIAMETER AND PLATING THICKNESS.
- △ REFERENCE APPLICATION SPEC. 114-13120, HOLE B, FOR RECOMMENDED DRILL HOLE DIAMETER AND PLATING THICKNESS.
- 11. CERTAIN MATING TRANSCEIVERS MAY REQUIRE ADDITIONAL PCB THICKNESS THAT WOULD BE DETERMINED BY THE CUSTOMER.
- 12. PRODUCT COMPLIES WITH SPECIFICATION SFF-8433 IMPROVED PLUGGABLE FORM FACTOR FOR SFP+ GANGED CAGES.
- △ DIMENSION APPLIES PRIOR TO INSERTION OF SFP MODULE.
- △ PACKAGED AS A COMPLETE ASSEMBLY.

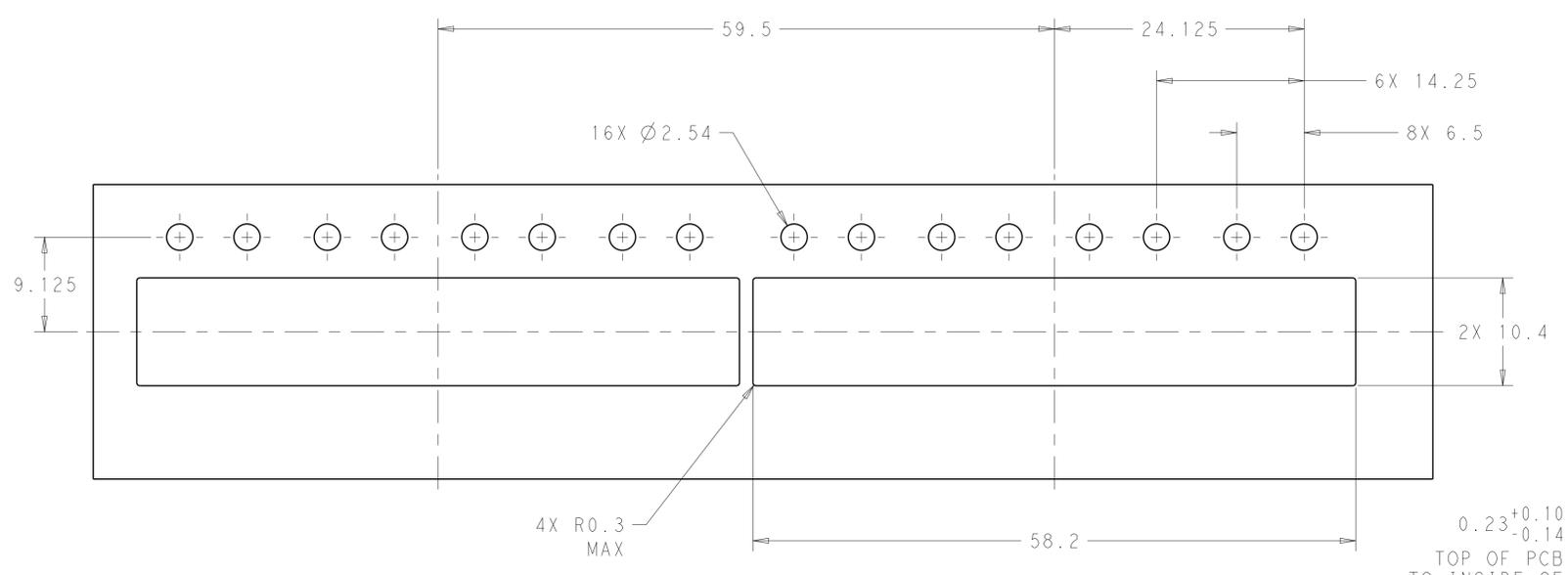


2149745-1
FINISHED ASSEMBLY
SCALE 5:2

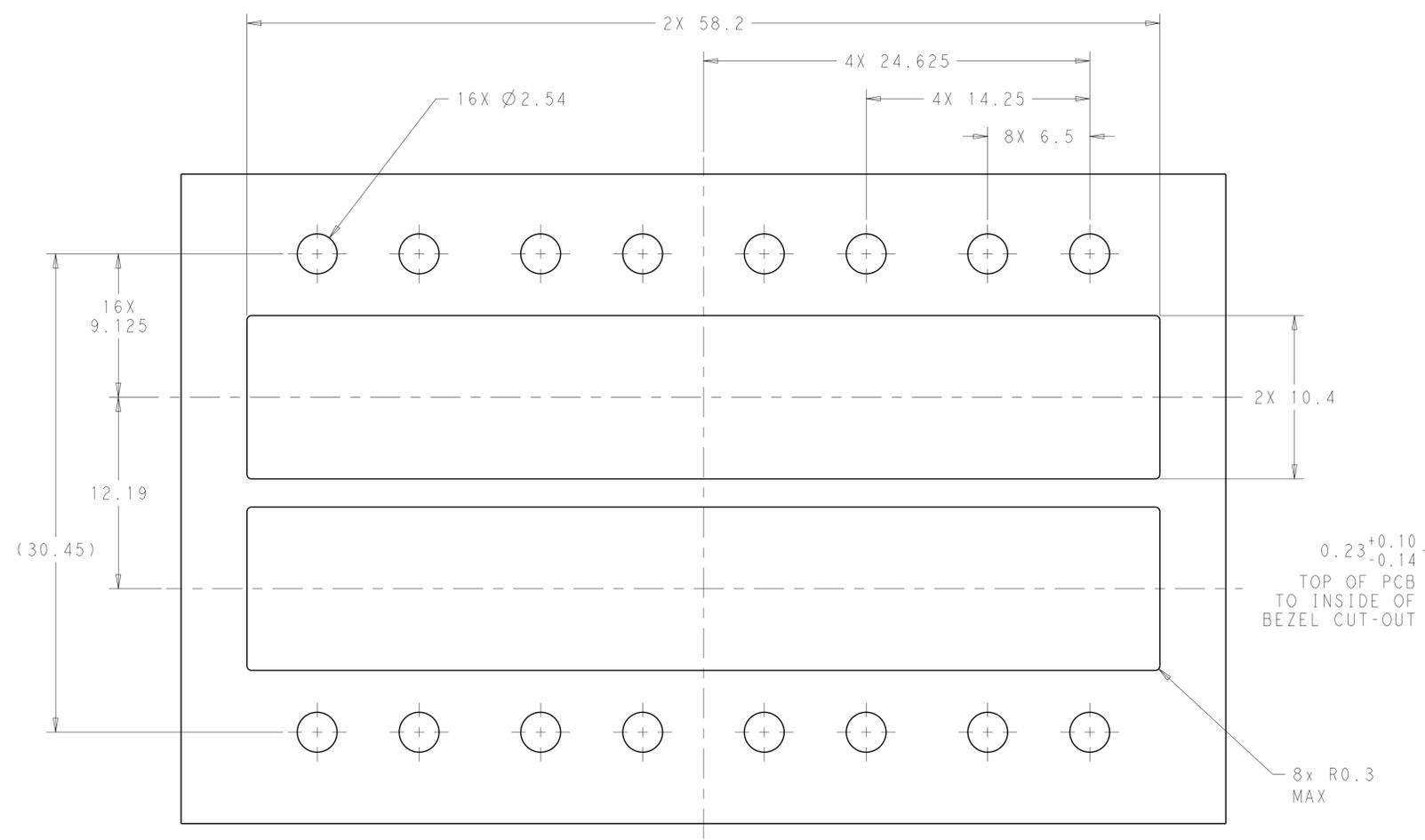
△	2149745-2
△	2149745-1
PART NUMBER	

THIS DRAWING IS A CONTROLLED DOCUMENT.		DWN: B. MATTHEWS 17AUG2010	TE Connectivity
DIMENSIONS: mm		CHK: M. SCHMITT 17AUG2010	
TOLERANCES UNLESS OTHERWISE SPECIFIED:		APVD: M. SCHMITT 17AUG2010	NAME: SFP+ ENHANCED 1X4 CAGE ASSEMBLY PRESS FIT, EXTERNAL EMI SPRINGS
0 PLC ±0.1		PRODUCT SPEC: 108-2364	
1 PLC ±0.1		APPLICATION SPEC: 114-13120	SIZE: A1
2 PLC ±0.1		WEIGHT: -	CAGE CODE: 00779
3 PLC ±0.1		RESTRICTED TO: -	DRAWING NO: 2149745
4 PLC ±0.1		SCALE: 4:1	SHEET 1 OF 4
ANGLES ±0.1		Customer Drawing	REV: A

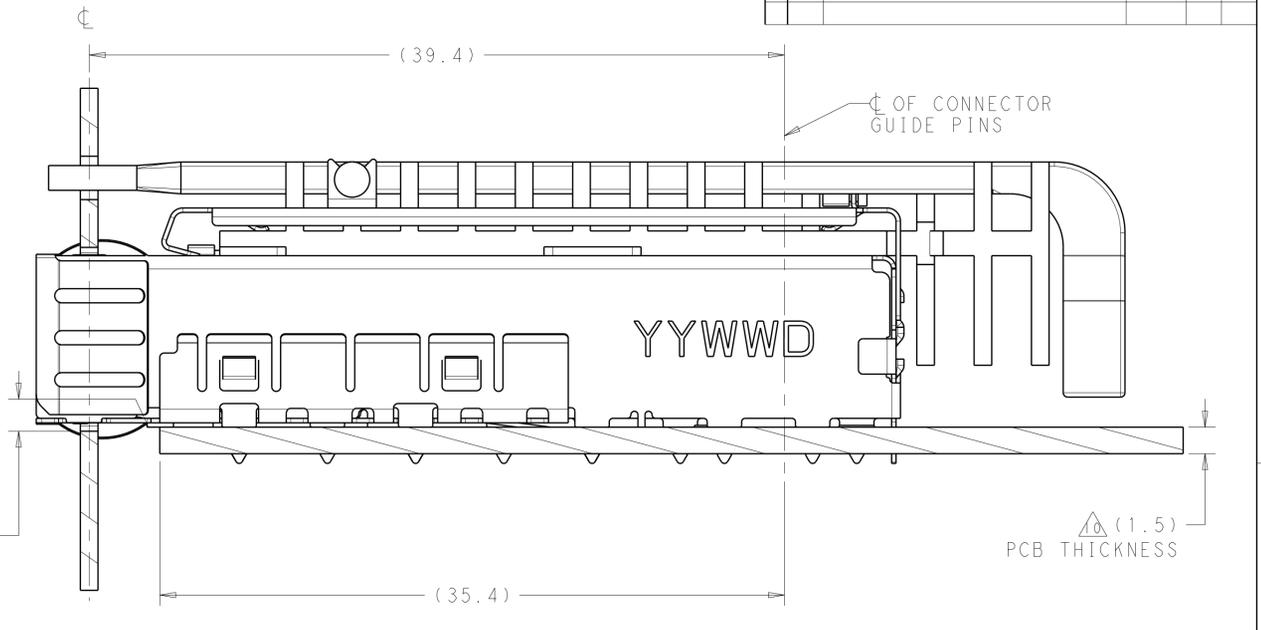
LOC		DIST		REVISIONS			
GP	00	P	LTN	DESCRIPTION	DATE	DMN	APVD
		-		SEE SHEET 1			



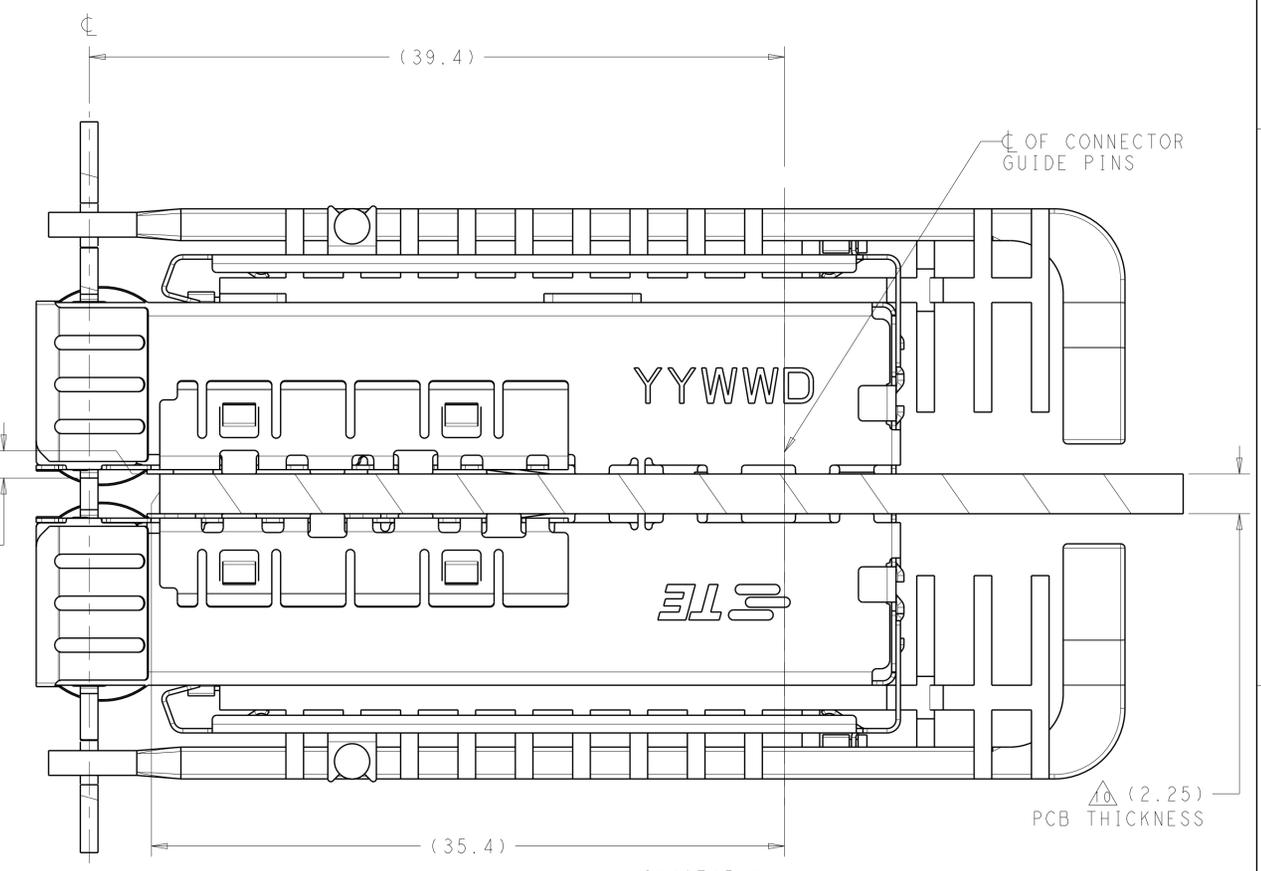
RECOMMENDED BEZEL CUT-OUT
SINGLE SIDED APPLICATIONS
SCALE 3:1



RECOMMENDED BEZEL CUT-OUT
BELLY TO BELLY APPLICATIONS



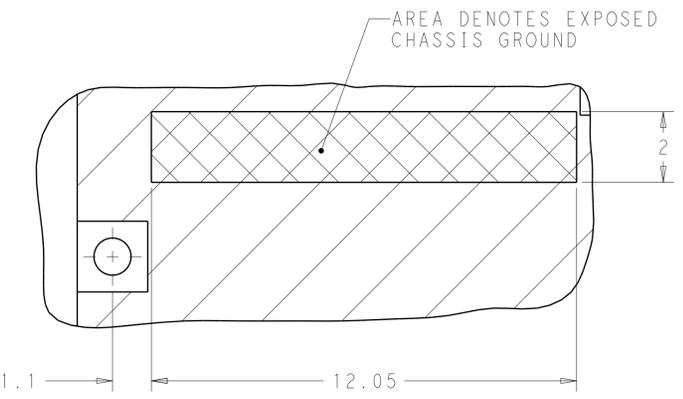
2149745-1
MOUNTED ON PC BOARD
SHOWN THRU RECOMMENDED BEZEL



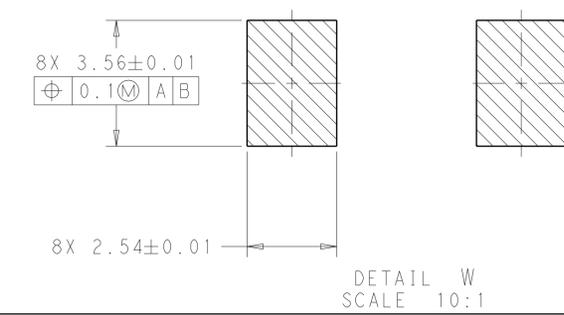
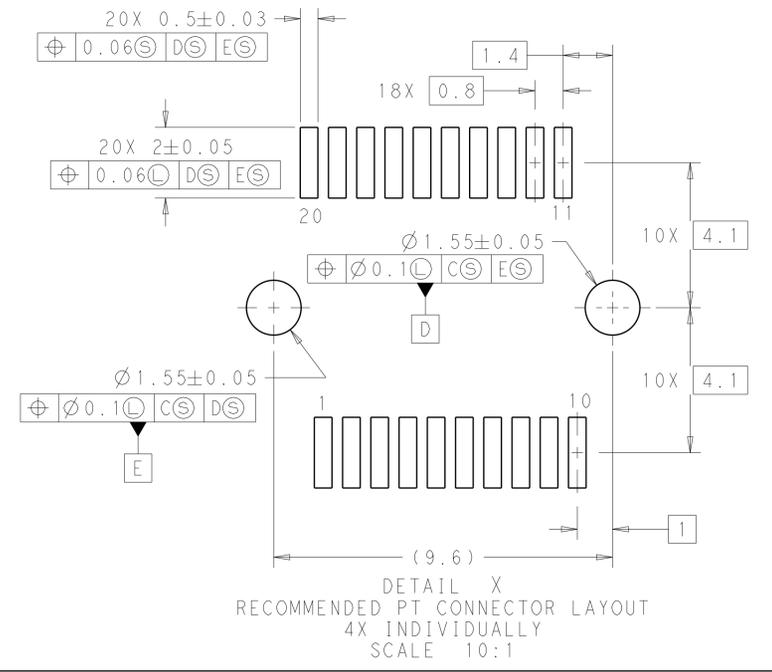
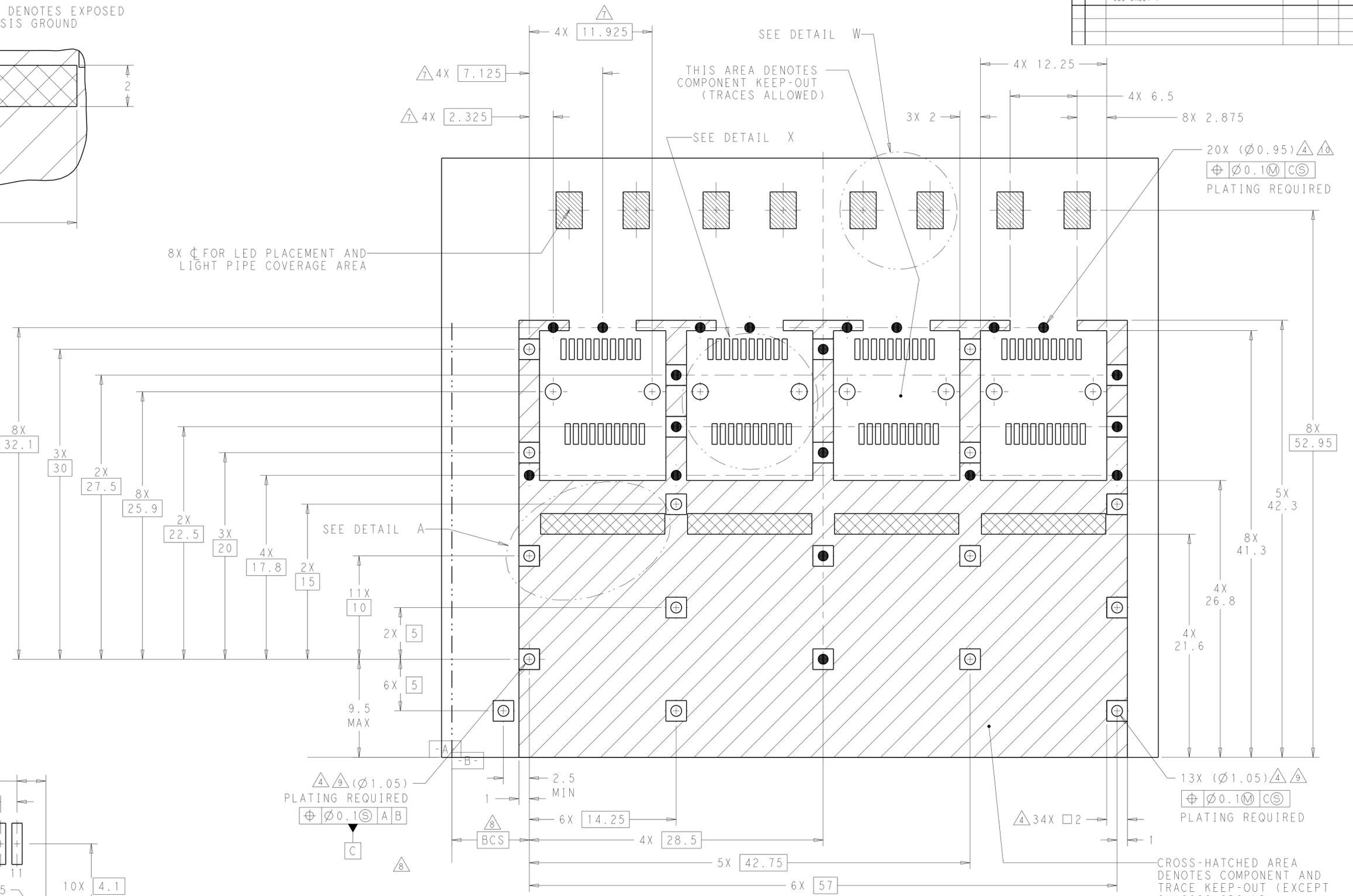
2149745-1
MOUNTED BELLY TO BELLY ON PC BOARD
SHOWN THRU RECOMMENDED BEZEL

THIS DRAWING IS A CONTROLLED DOCUMENT.		DMN: B. MATTHEWS 17AUG2010		TE Connectivity
DIMENSIONS: mm		CHK: M. SCHMITT 17AUG2010		NAME: SFP+ ENHANCED 1X4 CAGE ASSEMBLY PRESS FIT, EXTERNAL EMI SPRINGS
TOLERANCES UNLESS OTHERWISE SPECIFIED:		APVD: M. SCHMITT 17AUG2010	PRODUCT SPEC: 108-2364	RESTRICTED TO:
0 PLC ±0.1		APPLICATION SPEC: 114-13120	SIZE: A100779C=2149745	SCALE: 4:1
1 PLC ±0.1		WEIGHT: -	SHEET: 2 OF 4	REV: A
2 PLC ±0.1		Customer Drawing		
3 PLC ±0.1				
4 PLC ±0.1				
ANGLES ±0.1				
FINISH: -				

LOC	DIST	REV	DATE	APPD	REV	DATE	APPD
GP	00						



8X ϕ FOR LED PLACEMENT AND LIGHT PIPE COVERAGE AREA



THIS DRAWING IS A CONTROLLED DOCUMENT.		OWN: B. MATTHEWS 17AUG2010	TE Connectivity
DIMENSIONS: mm		CHK: M. SCHMITT 17AUG2010	
TOLERANCES UNLESS OTHERWISE SPECIFIED:		APVD: M. SCHMITT 17AUG2010	NAME: SFP+ ENHANCED 1X4 CAGE ASSEMBLY PRESS FIT, EXTERNAL EMI SPRINGS
0 PLC \pm 0.1		PRODUCT SPEC: 108-2364	
1 PLC \pm 0.1		APPLICATION SPEC: 114-13120	SIZE: CAGE CODE DRAWING NO: A100779C=2149745
2 PLC \pm 0.1		WEIGHT: -	
3 PLC \pm 0.1		Customer Drawing	RESTRICTED TO: -
4 PLC \pm 0.1		SCALE: 4:1	SHEET: 3 OF 4
ANGLES \pm 0.1		REV: A	

Данный компонент на территории Российской Федерации

Вы можете приобрести в компании MosChip.

Для оперативного оформления запроса Вам необходимо перейти по данной ссылке:

<http://moschip.ru/get-element>

Вы можете разместить у нас заказ для любого Вашего проекта, будь то серийное производство или разработка единичного прибора.

В нашем ассортименте представлены ведущие мировые производители активных и пассивных электронных компонентов.

Нашей специализацией является поставка электронной компонентной базы двойного назначения, продукции таких производителей как XILINX, Intel (ex.ALTERA), Vicor, Microchip, Texas Instruments, Analog Devices, Mini-Circuits, Amphenol, Glenair.

Сотрудничество с глобальными дистрибьюторами электронных компонентов, предоставляет возможность заказывать и получать с международных складов практически любой перечень компонентов в оптимальные для Вас сроки.

На всех этапах разработки и производства наши партнеры могут получить квалифицированную поддержку опытных инженеров.

Система менеджмента качества компании отвечает требованиям в соответствии с ГОСТ Р ИСО 9001, ГОСТ РВ 0015-002 и ЭС РД 009

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